was filed on



Docket Number: 1875.0210000

As a below named inventor, I hereby declare that:

My residence, mailing address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter that is claimed and for which a patent is sought on the invention entitled Enhanced Die-Down Ball Grid Array and Method for Making the Same, the specification of which is attached hereto unless the following box is checked:

| | | International Application application applicable). | n Number | ; and | |
|---|--|--|---|---|------------------------|
| I hereby state that I have revi amended by any amendment | | contents of the above id | entified specification | ı, including the cla | aims, as |
| I acknowledge the duty to dis | sclose information that is | material to patentability | as defined in 37 C.F. | .R. § 1.56. | |
| I hereby claim foreign priorit inventor's certificate, or § 36: United States listed below, ar international application havi | 5(a) of any PCT internati nd have also identified be | ional application, which colors applicated any foreign applicated | designated at least on ion for patent or inve | e country other the entor's certificate, | an the |
| Prior Foreign Application(s) | | · | | Priority | Claimed |
| (Application No.) | (Country) | (Day/Month/Ye | ear Filed) | □ Yes | □ No |
| (Application No.) | (Country) | (Day/Month/Ye | | □ Yes | □ No |
| (Application No.) | (Filing Date) | The state of the s | sional application(s) | listed below. | |
| (Application No.) | (Filing Date) | | | | |
| hereby claim the benefit underternational application designs application is not disclosuragraph of 35 U.S.C. § 112 C.F.R. § 1.56 that became availing date of this application | der 35 U.S.C. § 120 of an gnating the United States ed in the prior United States e, I acknowledge the duty ailable between the filing | ny United States applicat s, listed below and, insofa ates or PCT international to disclose information | ar as the subject matte application in the ma that is material to pat | er of each of the canner provided by tentability as defined | the first ned in 37 |
| (Application No.) | (Filing Date) | (Status | s - patented, pending, | abandoned) | |
| (Application No.) | (Filing Date) | (Status | - patented, pending, | abandoned) | |

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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